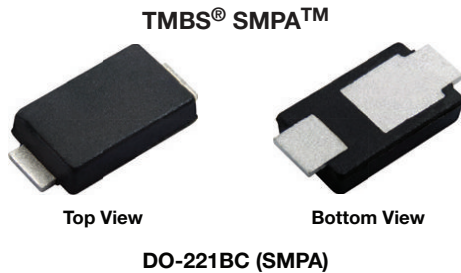


# Surface Mount Trench MOS Barrier Schottky Rectifier



## FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	8.0 A
$V_{RRM}$	45 V
$I_{FSM}$	120 A
$V_F$ at $I_F = 8.0$ A ( $T_A = 125$ °C)	0.40 V
$T_J$ max.	150 °C
Package	DO-221BC (SMPA)
Diode variation	Single die

## MECHANICAL DATA

**Case:** DO-221BC (SMPA)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Base P/NHM3\_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("\_X" denotes revision code e.g. A, B,.....)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes cathode end

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)			
PARAMETER	SYMBOL	V8PAL45	UNIT
Device marking code		8L45	
Maximum repetitive peak reverse voltage	$V_{RRM}$	45	V
Maximum DC forward current	$I_F^{(1)}$	8.0	A
	$I_F^{(2)}$	4.0	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	120	A
Operating junction and storage temperature range	$T_J, T_{STG}$	-40 to +150	°C

### Notes

- (1) Units mounted on 3 cm x 3 cm aluminum, 2 oz. PCB
- (2) Free air, mounted on recommended copper pad area

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	$I_F = 4.0\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.43	-	V
	$I_F = 8.0\text{ A}$			0.49	0.57	
	$I_F = 4.0\text{ A}$	$T_A = 125\text{ }^\circ\text{C}$		0.32	-	
	$I_F = 8.0\text{ A}$			0.40	0.48	
Reverse current	$V_R = 45\text{ V}$	$T_A = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	-	1850	$\mu\text{A}$
		$T_A = 125\text{ }^\circ\text{C}$		11	30	mA
Typical junction capacitance	4.0 V, 1 MHz	$C_J$	1400	-	pF	

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle  
 (2) Pulse test: pulse width  $\leq 5\text{ ms}$

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise specified)			
PARAMETER	SYMBOL	V8PAL45	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	100	$^\circ\text{C/W}$
	$R_{\theta JM}^{(2)}$	5	

**Notes**

- (1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient  
 (2) Units mounted on 3 cm x 3 cm aluminum, 2 oz. pad area; thermal resistance  $R_{\theta JM}$  - junction to mount

<b>ORDERING INFORMATION</b> (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V8PAL45-M3/I	0.032	I	14 000	13" diameter plastic tape and reel
V8PAL45HM3/I <sup>(1)</sup>	0.032	I	14 000	13" diameter plastic tape and reel
V8PAL45HM3_A/I <sup>(1)</sup>	0.032	I	14 000	13" diameter plastic tape and reel

**Note**

- (1) AEC-Q101 qualified

**RATINGS AND CHARACTERISTICS CURVES**

( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

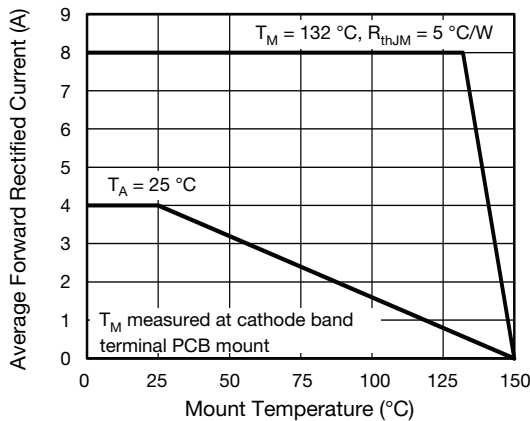


Fig. 1 - Maximum Forward Current Derating Curve

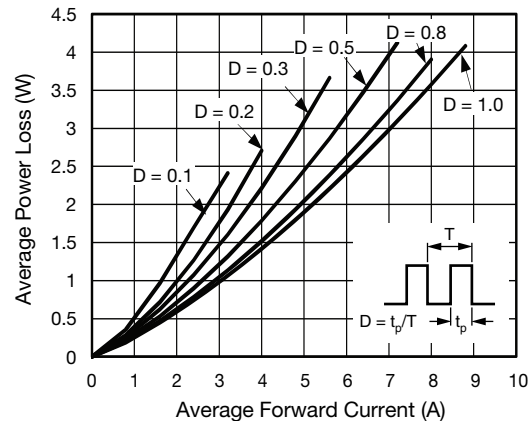


Fig. 2 - Forward Power Loss Characteristics

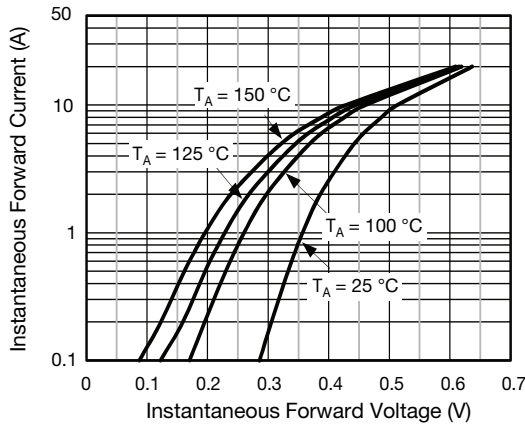


Fig. 3 - Typical Instantaneous Forward Characteristics

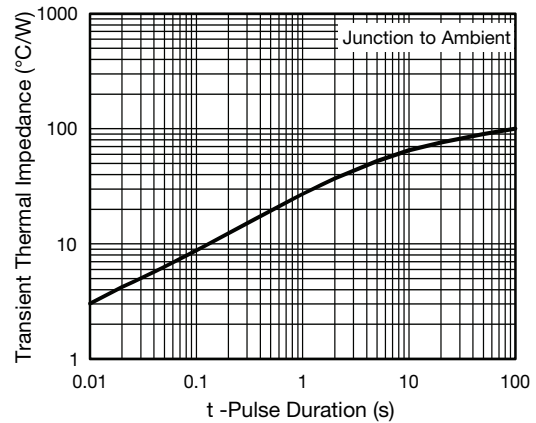


Fig. 6 - Typical Transient Thermal Impedance

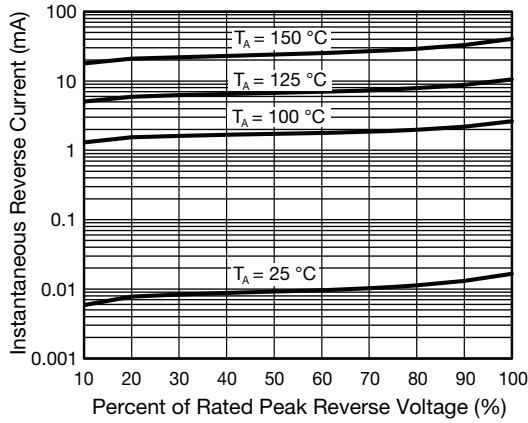


Fig. 4 - Typical Reverse Leakage Characteristics

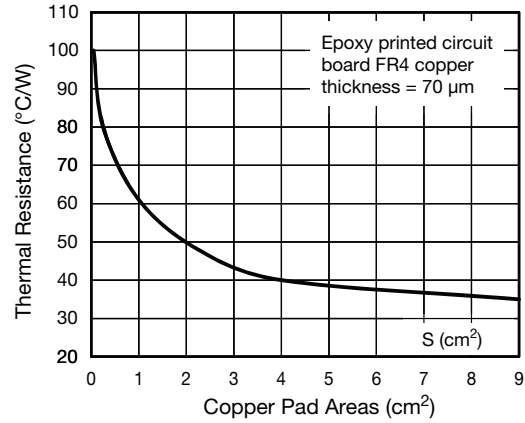


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

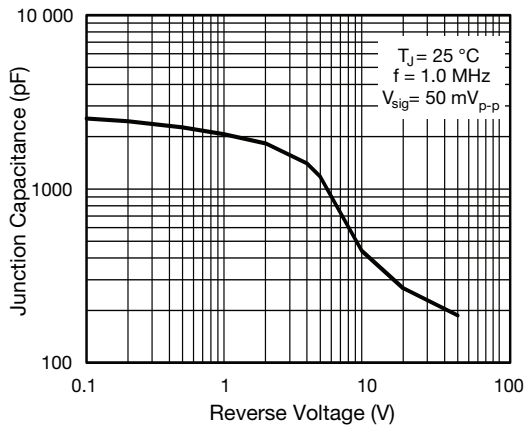
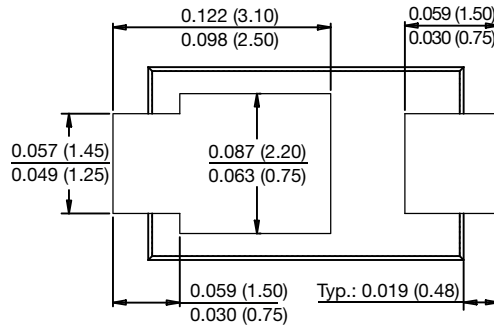
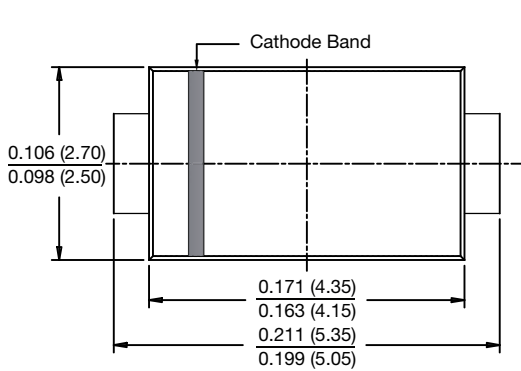


Fig. 5 - Typical Junction Capacitance

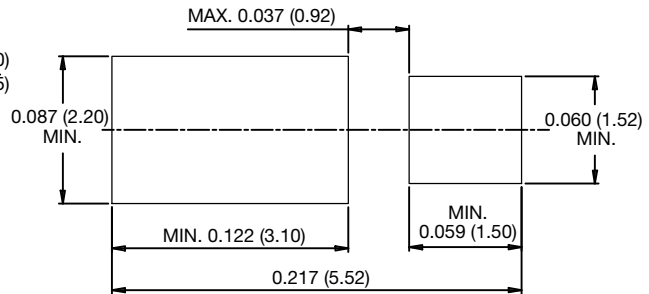
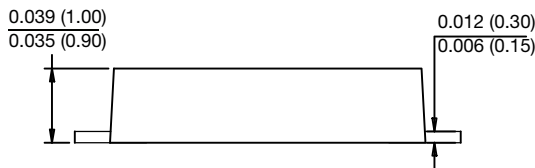


**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

**DO-221BC (SMPA)**



**Mounting Pad Layout**





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